Chapter 4

Sequential Machines

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Figure 4..1: Events on a gate.



Figure 4..2: Discrete values in combinational logic.



Figure 4..3: Events in a combinational network.



Figure 4..4: Critical delay paths.



Figure 4..5: Inverter gain from the transfer curve.



Figure 4..6: Gain and logic levels.



Figure 4..7: Effects of high and low gain on signal levels



Figure 4..8: Ramp response of an inverter.



Figure 4..9: Nonideal waveforms.



Figure 4.10: Trajectory of transistor current during fast- and slow-rising inputs.



Figure 4.11: Voltage waveform for step and ramp inputs.



Figure 4.12: Effects of slowing down gates on the critical path.



Figure 4.13: A mechanical governor.

V _{DD}	GND
	-
	-
CNID	

Figure 4.14: A mechanical governor.



Figure 4.15: A mechanical governor.



Figure 4.16: Circuit model for ground bounce and logic gates.



Figure 4.17: Circuit model for ground bounce and current.



Figure 4.18: The effect of ground bounce on the gate transfer characteristic.



Figure 4.19: Effect of ground bounce on gate-to-gate communication.



Figure 4.20: Logic blocks and current demands.



Figure 4.21: A decoupling capacitor for the power supply wiring.



Figure 4.22: Coupling between the input and output of an inverter.



Figure 4.23: Miller capacitance.



Figure 4.24: Gate/substrate and Miller capacitances.



Figure 4.25: Resistance of squares is independent of square dimensions.

	Ι	→
square	square	square

Figure 4.26: Wire resistance is measured along the direction of current flow.



Figure 4.27: A transmission line.



Figure 4.28: A section of an RLC transmission line.



Figure 4.29: An RC transmission line.



Figure 4.30: Propagation of a step input along an RC transmission line.



Figure 4.31: Distortion of a pulse traveling along a transmission line.



Figure 4.32: Performance of a series of RC sections.



Figure 4.33: Currents in the Elmore model.



Figure 4.34: Resistance and capacitance along a nonuniform wire.



Figure 4.35: Capacitive couplings of wires.



Figure 4.36: Capacitive coupling between wires..



Figure 4.37: Shielded wires.



Figure 4.38: Twizzled wires.



Figure 4.39: Partitioning as a measure of wiring complexity.



Figure 4.40: Recursive partitioning for wiring estimation.



Figure 4.41: Wire length estimation by Euclidean distance.



Figure 4.42: The combinational abstraction for logic.



Figure 4.43: Signals in discrete time.



Figure 4.44: A sequential machine.

input	present	next	output
	state	state	
0	00	00	0
1	00	01	0
0	01	01	0
1	01	10	0
0	10	10	0
1	10	00	1



Figure 4.45: State transition tables and graphs.



Figure 4.46: An FSM with an unspecified state.



Figure 4.47: Circuit schematic for a dynamic latch.



Figure 4.48: A static latch circuit.



Figure 4.49: A master-slave flip-flop.



Figure 4.50: Setup and hold times.



Figure 4.51: A simple analytical model for a register.



Figure 4.52: Sequential machines and clock period.



Figure 4.53: Errors caused by too-fast clocking.





pipelined machine

Figure 4.54: Pipelining.



Figure 4.55: Problems with a single rank of latches.



Figure 4.56: Two-phase, nonoverlapping clocks for latches.



Figure 4.57: Clock delay and skew.



Figure 4.58: The effect of clock skew on system timing.



Figure 4.59: Metastability in cross-coupled inverters.



Figure 4.60: Energy versus system state for a register.



Figure 4.61: Metastable exponential divergence.



Figure 4.62: The vulnerable interval for metastability.



Figure 4.63: The stabilization window.



Figure 4.64: A dual-register synchronizer.

Example 4.4 Resistance and Capacitance Measurements.



Q4-1



Q4-2



Q4-3.